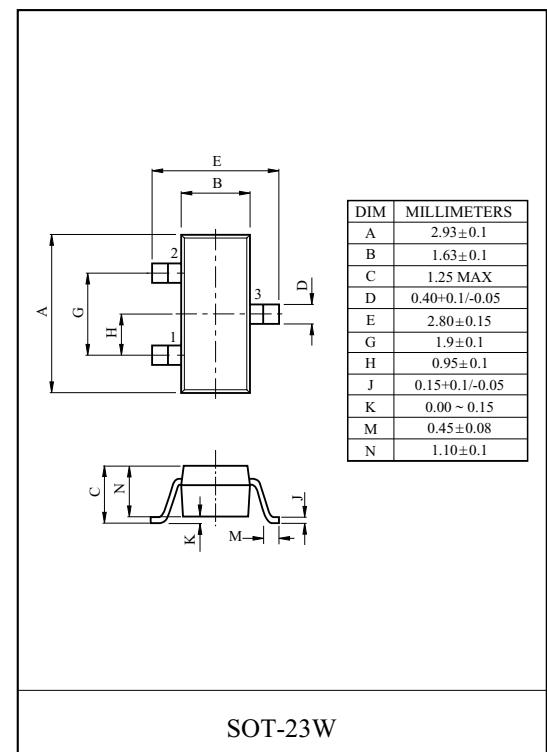


General Description

It's mainly suitable for use as a load switch in battery powered applications.

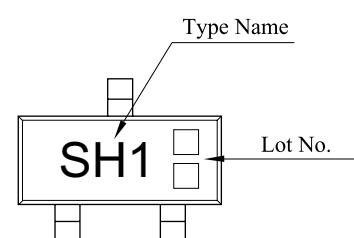
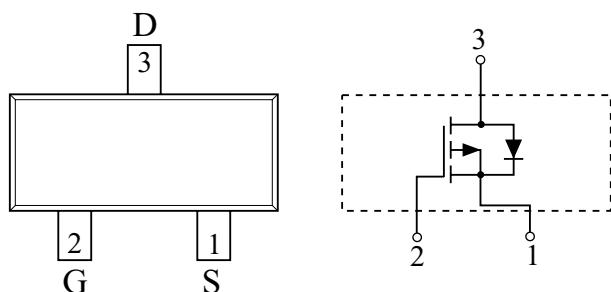
FEATURES

- $V_{DSS} = -20V$, $I_D = -2.3A$.
- Drain-Source ON Resistance.
 - : $R_{DS(ON)} = 130m\Omega$ (Max.) @ $V_{GS} = -4.5V$.
 - : $R_{DS(ON)} = 190m\Omega$ (Max.) @ $V_{GS} = -2.5V$.

**MAXIMUM RATING (Ta=25 °C)**

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V_{GSS}	± 10	V
Drain Current	DC	I_D *	-2.3	A
	Pulsed (Note1)	I_{DP} *	-8	
Source-Drain Diode Current		I_S *	-1.25	A
Drain Power Dissipation	Ta=25 °C	P_D *	1.25	W
Maximum Junction Temperature		T_j	150	°C
Storage Temperature Range		T_{stg}	-55 ~ 150	°C
Thermal Resistance, Junction to Ambient		R_{thJA} *	100	°C/W

* : Surface Mounted on 1" × 1" FR4 Board

Marking**PIN CONNECTION (TOP VIEW)**

KMA2D3P20S

ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =-250μA, V _{GS} =0V,	-20	-	-	V
Drain Cut-off Current	I _{DSS}	V _{GS} =0V, V _{DS} =-16V	-	-	-1	μA
Gate Leakage Current	I _{GSS}	V _{GS} =±10V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{th}	V _{DS} =V _{GS} , I _D =-250μA (Note 1)	-0.5	-0.8	-1.5	V
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-2.3A (Note 1)	-	115	130	mΩ
		V _{GS} =-2.5V, I _D =-1.0A (Note 1)	-	175	190	
ON State Drain Current	I _{D(ON)}	V _{GS} =-4.5V, V _{DS} =-5V (Note 1)	-5	-	-	A
Forward Transconductance	g _{fs}	V _{DS} =-5V, I _D =-2.3A (Note 1)	-	6	-	S
Source-Drain Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-1.25A (Note 1)	-	-0.85	-1.2	V
Dynamic (Note 2)						
Total Gate Charge	Q _g	V _{DS} =-10V, I _D =-2.3A V _{GS} =-4.5V (Fig.1)	-	3.2	-	nC
Gate-Source Charge	Q _{gs}		-	0.7	-	
Gate-Drain Charge	Q _{gd}		-	0.8	-	
Turn-on Delay time	t _{d(on)}	V _{DS} =-10V, I _D =-1A V _{GS} =-4.5V, R _G =6Ω (Fig.2)	-	9.8	-	ns
Turn-on Rise time	t _r		-	10.8	-	
Turn-off Delay time	t _{d(off)}		-	79.1	-	
Turn-off Fall time	t _f		-	41.3	-	
Input Capacitance	C _{iss}	V _{DS} =-20V, V _{GS} =0V f = 1.0MHz	-	290	-	pF
Output Capacitance	C _{oss}		-	60	-	
Reverse Transfer Capacitance	C _{rss}		-	45	-	

Note 1) Pulse test : Pulse width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.

Note 2) Guaranteed by design. Not subject to production testing.

KMA2D3P20S

Fig1. I_D - V_{DS}

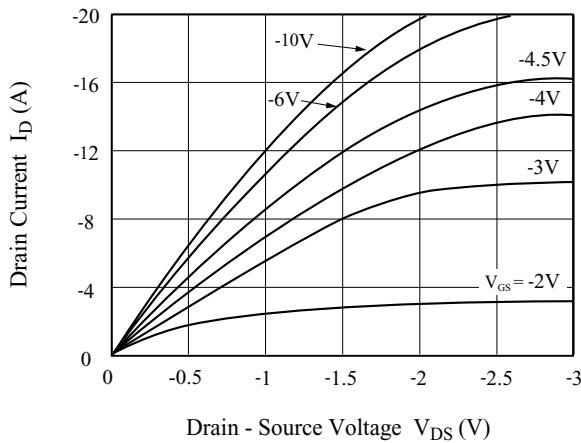


Fig2. I_D - V_{GS}

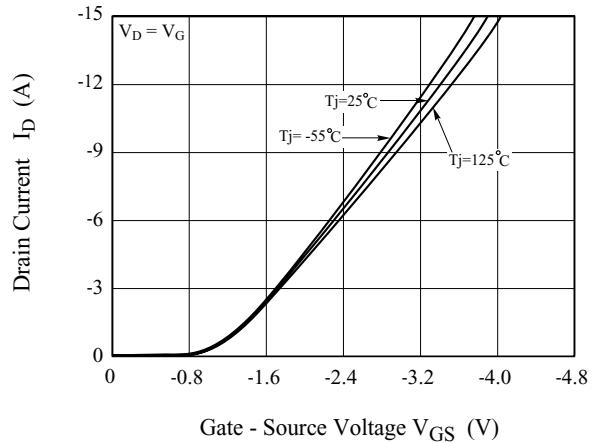


Fig3. V_{th} - T_j

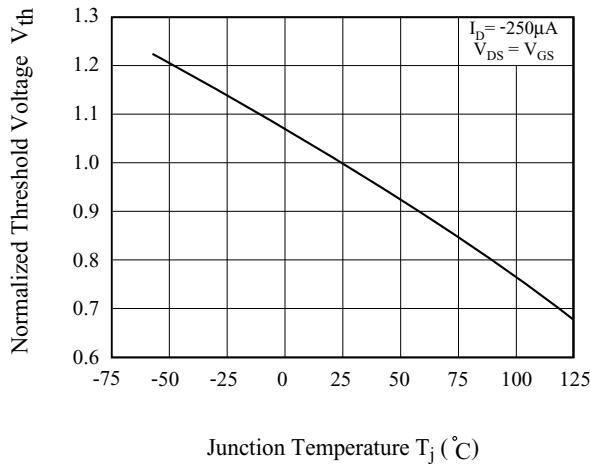


Fig4. I_S - V_{SD}

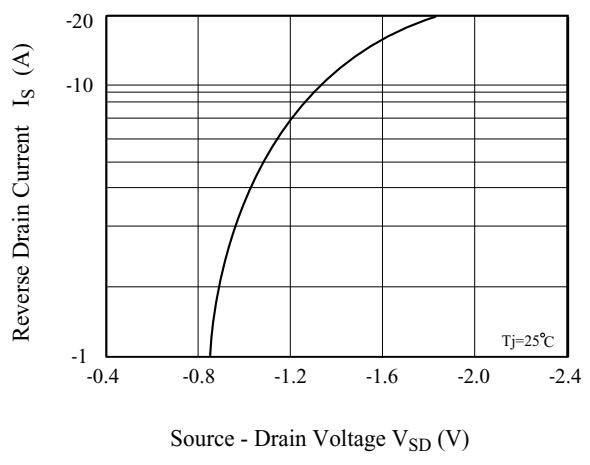


Fig5. $R_{DS(ON)}$ - T_j

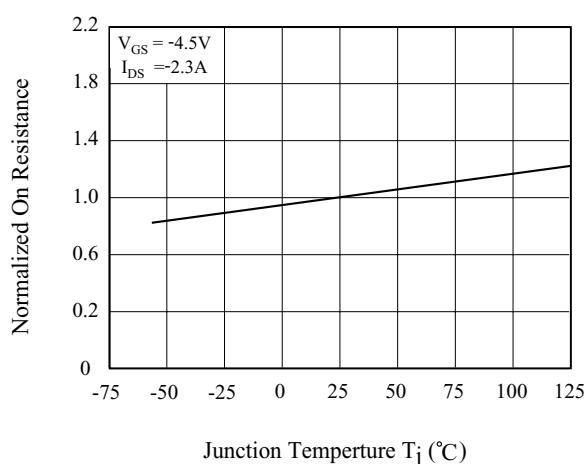
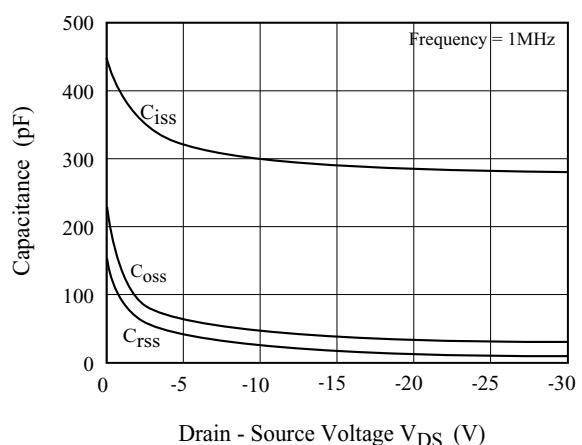


Fig6. C - V_{DS}



KMA2D3P20S

Fig7. Q_g - V_{GS}

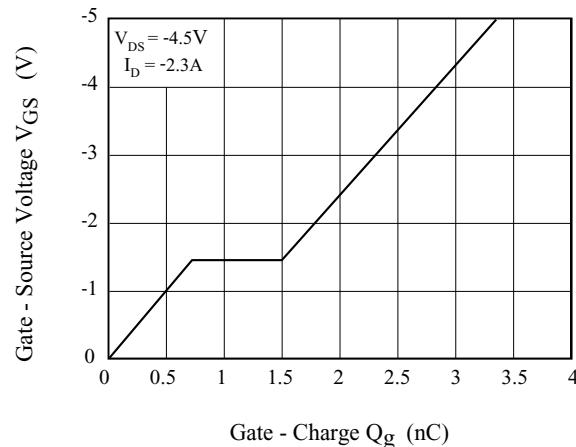


Fig8. Safe Operation Area

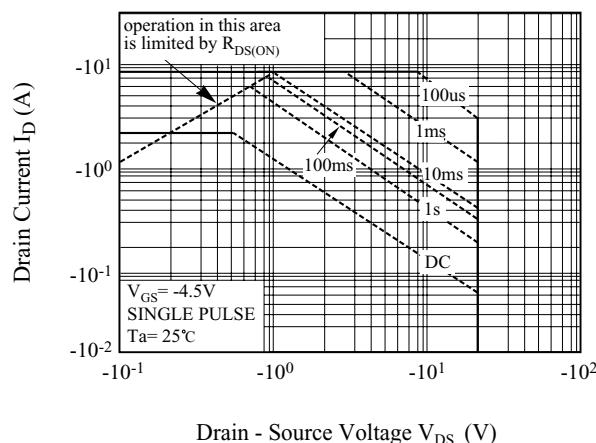
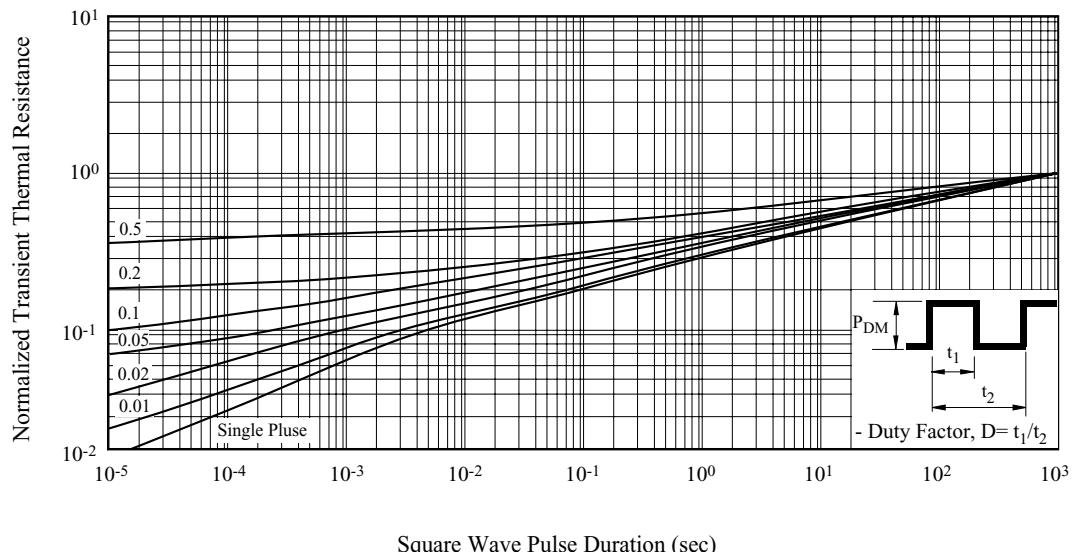


Fig9. Transient Thermal Response Curve



KMA2D3P20S

Fig10. Gate Charge

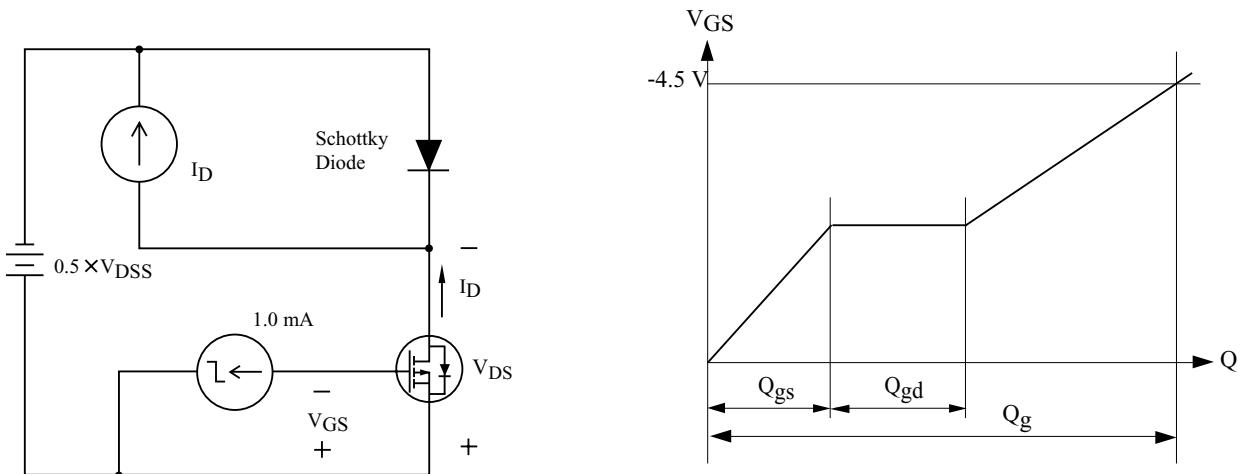


Fig11. Resistive Load Switching

